



H-997

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of

T. DANNO et al.

Group Art Unit: 2823

Serial No. 09/910,833

Examiner: F. Toledo

Filed: July 24, 2001

For: A SEMICONDUCTOR DEVICE MANUFACTURING METHOD WHEREIN
ELECTRODE MEMBERS ARE EXPOSED FROM A MOUNTING
SURFACE OF A RESIN ENCAPSULATOR (As Amended)

REQUEST TO CORRECT NOTICE OF ALLOWANCE

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

August 3, 2004

Sir:

Please correct the Notice of Allowance mailed July 12,
2004 as follows:

In the title, please change "SEMICONDUCTOR DEVICE
ANUFACTURING METHOD WHEREIN ELECTRODE MEMBERS ARE EXPOSED FROM
A MOUNTING SURFACE OF A RESIN ENCAPSULATOR" TO --**Semiconductor
Device Manufacturing Method Wherein Electrode Members are
Exposed From a Mounting Surface of a Resin Encapsulator--.**

In addition, Applicants respectfully request that the
Examiner acknowledge the Information Disclosure Statement and
PTO Form 1449 filed on December 16, 2003 on the corrected
Notice of Allowability.

The undersigned requests that a corrected Notice of Allowance be issued.

Respectfully submitted,

A handwritten signature in black ink, appearing to read "Daniel J. Stanger". The signature is fluid and cursive, with the first name "Daniel" and last name "Stanger" clearly distinguishable.

Daniel J. Stanger
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Date: August 3, 2004